

Solid State Relay OCMOS FET PS7241-2B

8-PIN SOP, 400 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 2-ch Optical Coupled MOS FET

DESCRIPTION

The PS7241-2B is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally close (N.C.) contact MOS FETs on the output side.

It is suitable for analog signal control because of their low offset and high linearity.

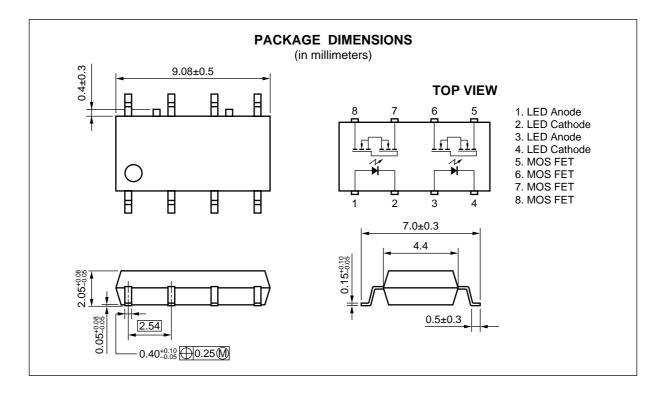
FEATURES

- 2 channel type (1 b + 1 b output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- · Low offset voltage
- Ordering number of taping product: PS7241-2B-F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8241/8242
- CSA approved: No. CA 101391

APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS7241-2B	8-pin SOP	Magazine case 45 pcs	PS7241-2B
PS7241-2B -F3		Embossed Tape 1 500 pcs/reel	
PS7241-2B -F4			

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5	V
	Power Dissipation	PD	50	mW/ch
	Peak Forward Current ^{*1}	IFP	1	А
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	١L	120	mA
	Pulse Load Current ^{*2} (AC/DC Connection)	Ilp	200	mA
	Power Dissipation	PD	180	mW/ch
Isolation Voltage ^{*3}		BV	1 500	Vr.m.s.
Total Power Dissipation		Ρτ	460	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 μ s, Duty Cycle = 1 %

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

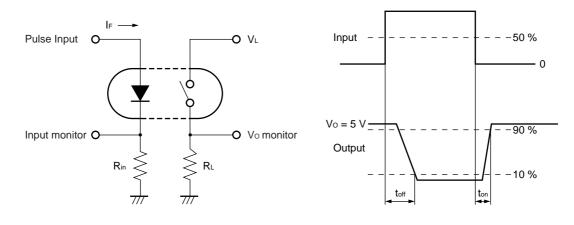
RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V _R = 5 V			5	μA
MOS FET	Off-state Leakage Current	Loff	IF = 10 mA, VD = 400 V		0.03	1.0	μA
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1.0 MHz		185		pF/ch
Coupled	LED Off-state Current	Foff	I∟ = 120 mA			2.0	mA
	On-state Resistance	Ron1	IF = 0 mA, IL = 10 mA		21	30	Ω
		Ron2	$I_F=0\ mA,\ I_L=120\ mA,\ t\leq 10\ ms$		16	25	
	Turn-on Time ^{*1}	ton	$I_{F} = 10 \text{ mA}, \text{ Vo} = 5 \text{ V}, \text{ R}_{L} = 500 \Omega,$		0.02	0.2	ms
	Turn-off Time ^{*1}	toff	PW ≥ 10 ms		0.1	1.0	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 [°]			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1.0 MHz		0.4		pF/ch

*1 Test Circuit for Switching Time



*

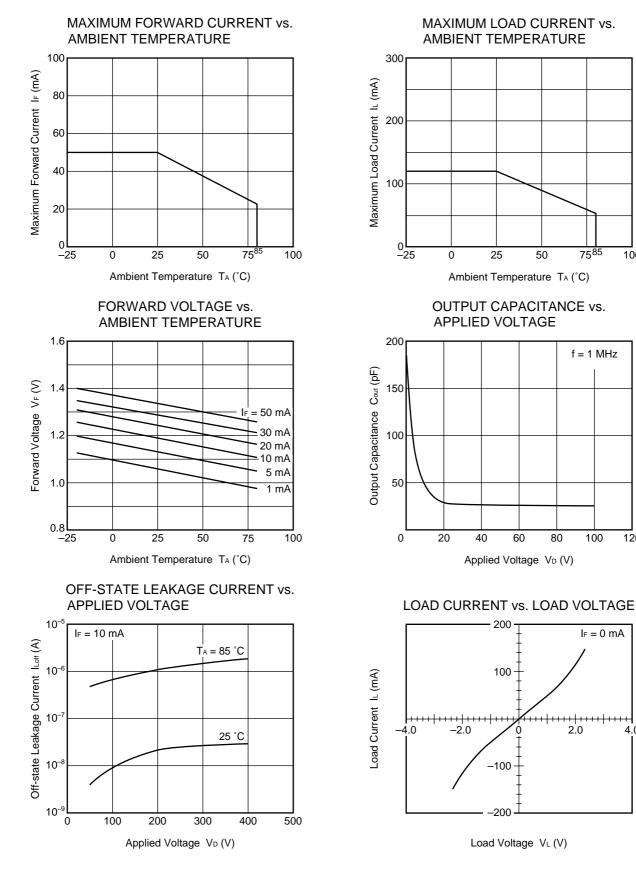
100

100

120

4.0

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)



NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE 3.0 Ron Normalized to 1.0 at $T_A = 25$ °C, Normalized On-state Resistance 2.5 $I_F = 0 \text{ mA},$ I∟ = 10 mA 2.0 1.5 1.0 0.5 0.0∟ _25



Ambient Temperature T_A (°C)

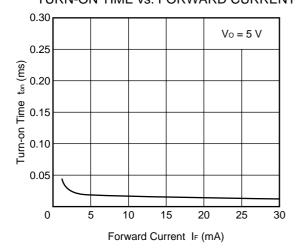
50

75

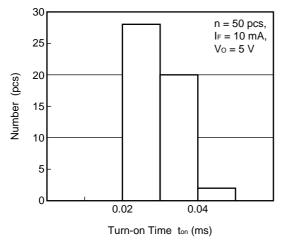
100

25

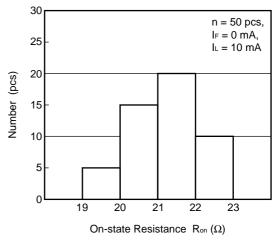
0



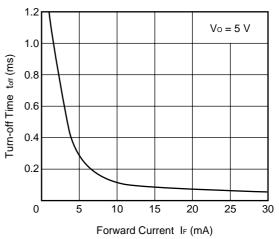




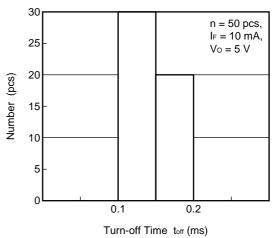
ON-STATE RESISTANCE DISTRIBUTION

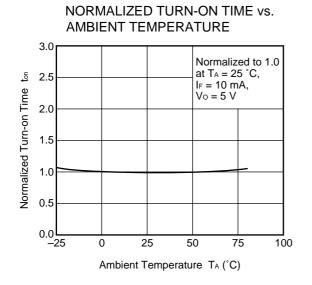


TURN-OFF TIME vs. FORWARD CURRENT

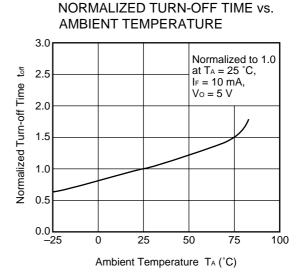


TURN-OFF TIME DISTRIBUTION

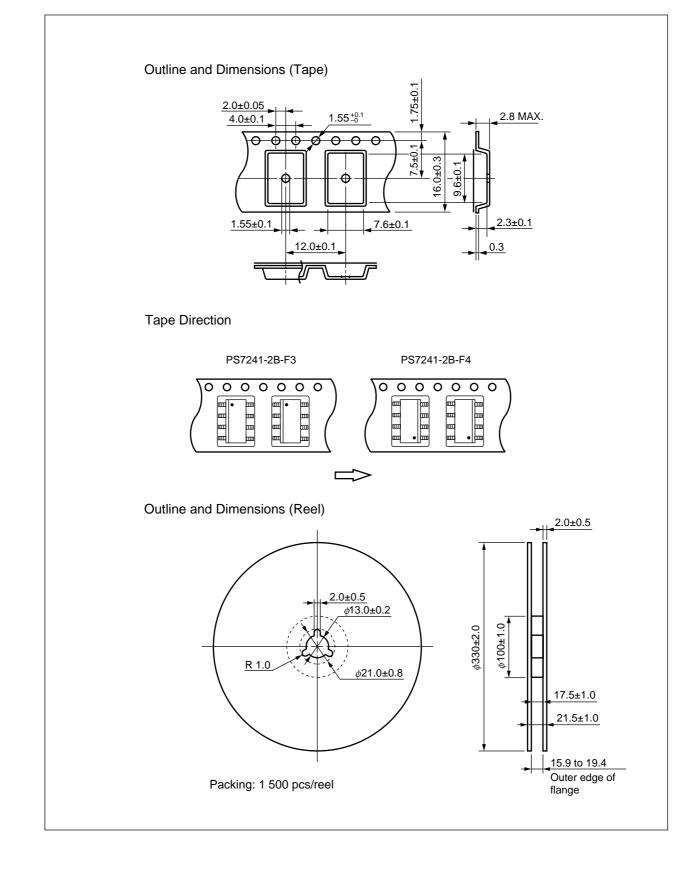




Remark The graphs indicate nominal characteristics.



★ TAPING SPECIFICATIONS (in millimeters)



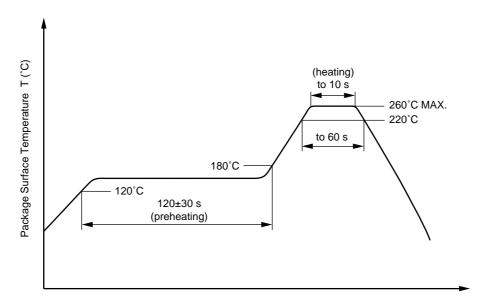
★ RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.
	Do not destroy or burn the product.
	Do not cut or cleave off any part of the product.
	Do not crush or chemically dissolve the product.
	Do not put the product in the mouth.
	Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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header	SITE MAP _ CONTACT US _
Advanced	Products > Lead (Pb)-free Information > Identification of Lead-Free Products
	Part Number
	The product type is indicated by a code suffixed to the part number.
	A Type of lead-free product Identification code Comment -A -A Product contains no lead in any area -A -AX Product has Ni/Pd/Au plating on external pins Partially lead free -AZ Product contains lead in some areas
	 Product Marking A dot "•" is used as the lead free mark. The lead free identification codes -A, -AX, and -AZ do not appear in the product marking.
	Marking example Marking example
	Identification on Packing Label
	Both totally lead-free products and partially lead-free products include the indication "Pb-Free T." on t packing label.

